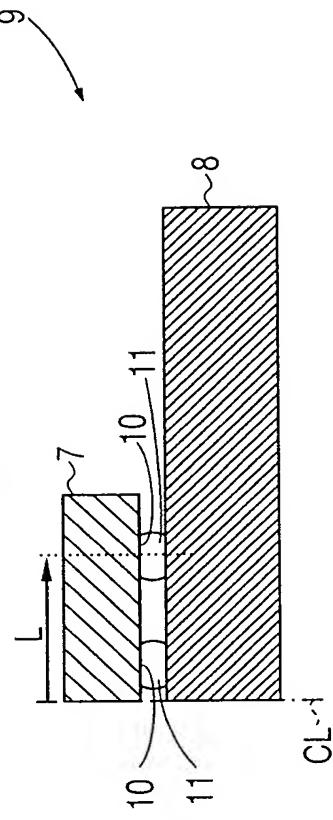
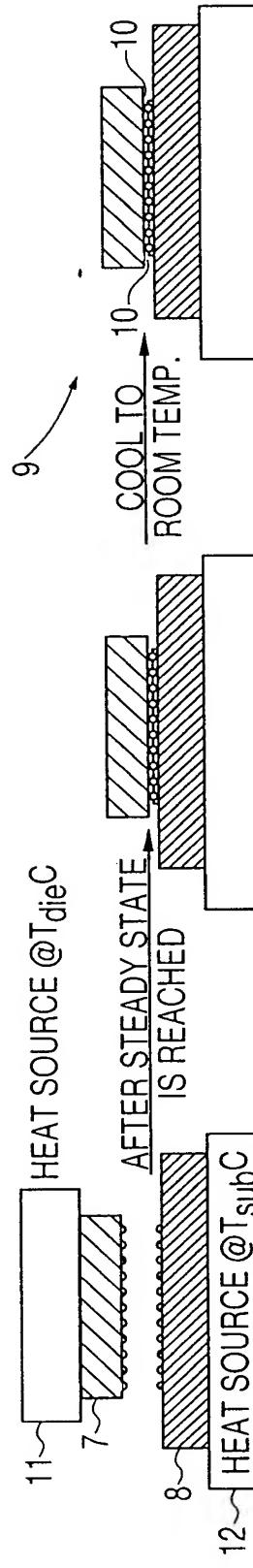


ROTATE T = 65°F/E 200°F

**FIG. 1**



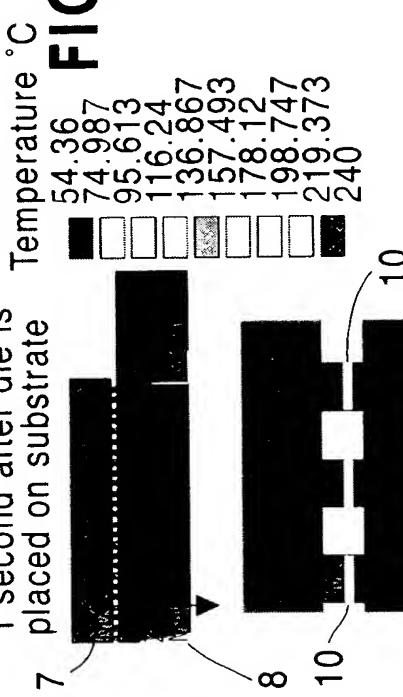
**FIG. 2**



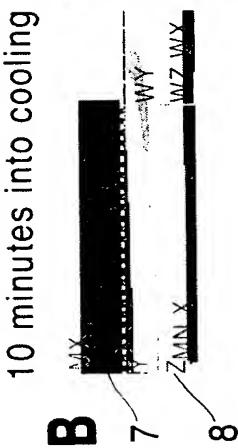
ALIGN, AND PLACE DIE ON SUBSTRATE      COOL TO ROOM-TEMPERATURE

**FIG. 3A**

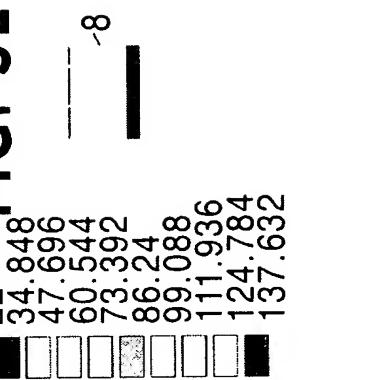
1 second after die is placed on substrate



**FIG. 3D**

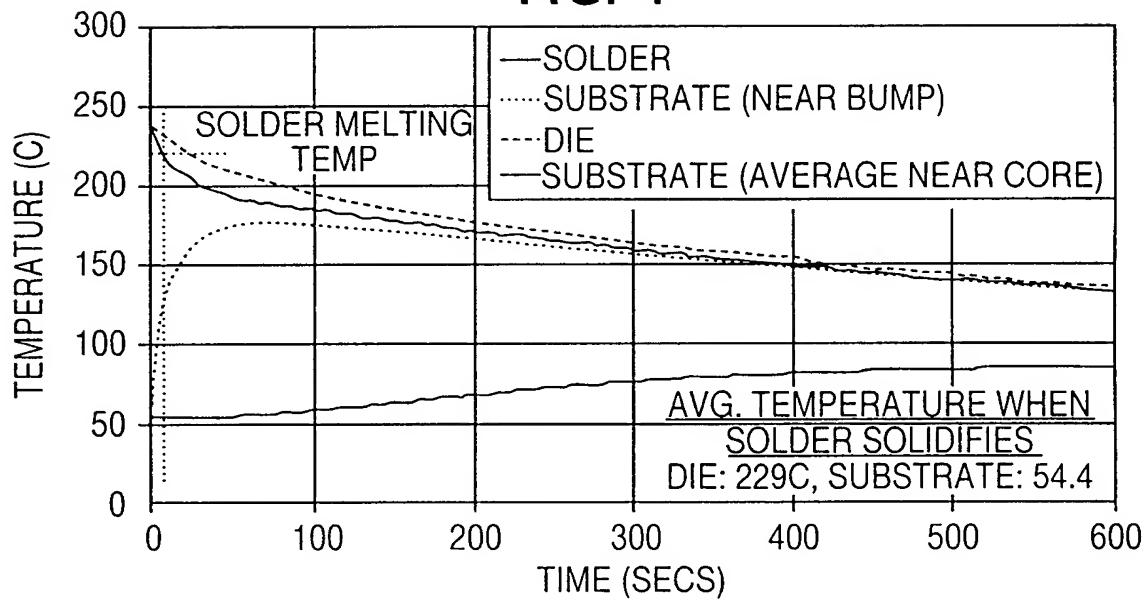


**FIG. 3C**



**FIG. 3E**

### FIG. 4



### FIG. 5

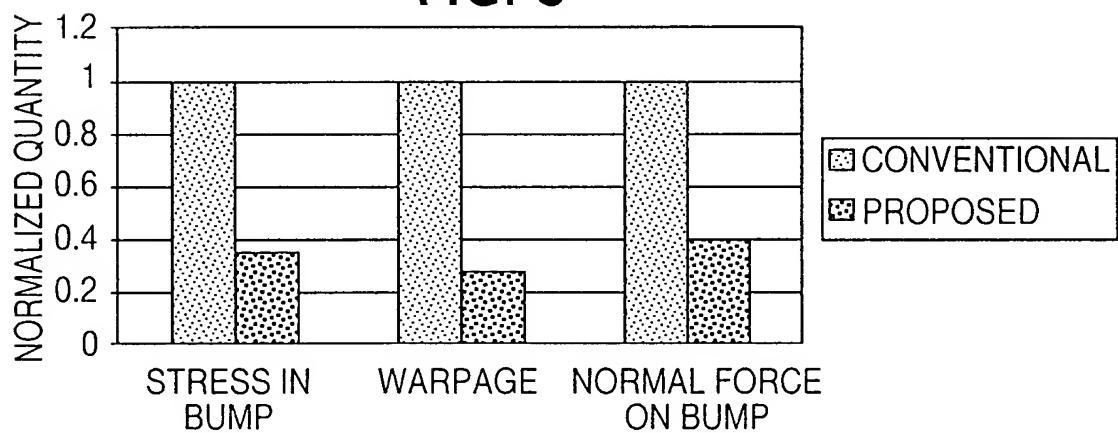
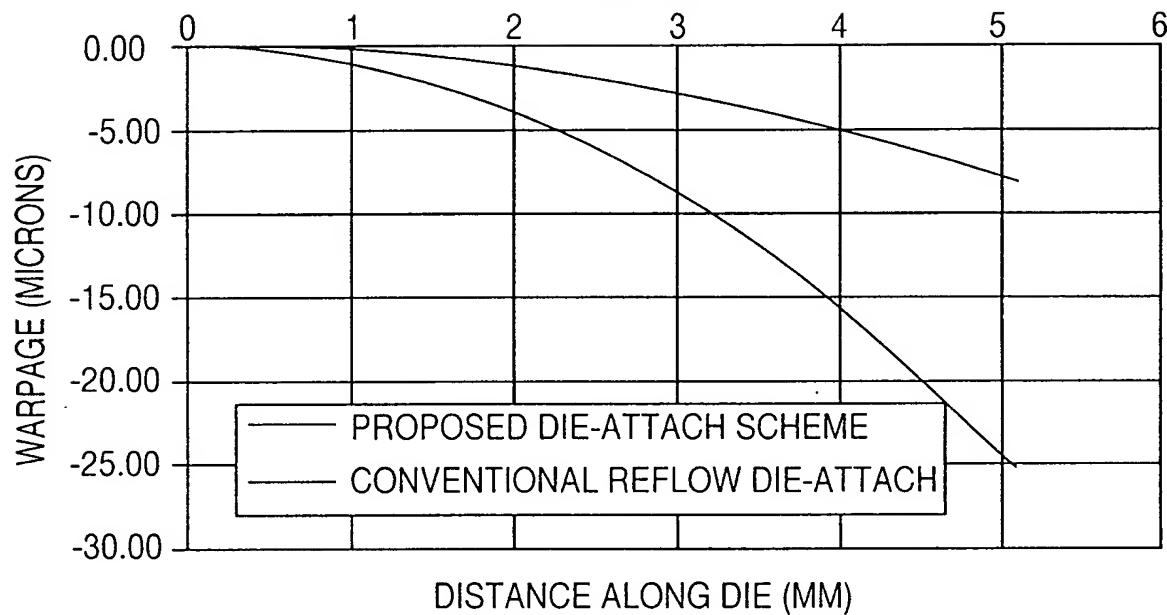


FIG. 6



TOP SECRET - 67352807

FIG. 7A  
(PRIOR ART)

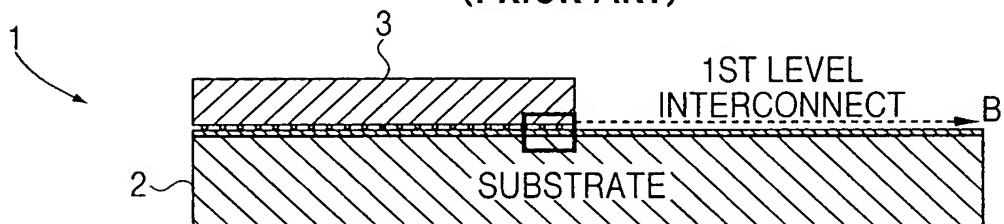


FIG. 7B  
(PRIOR ART)

